

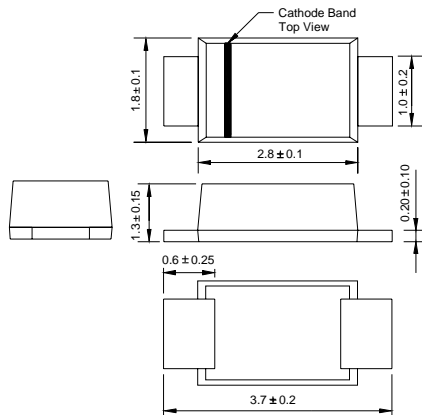


RS1AL THRU RS1ML

SURFACE MOUNT FAST RECOVERY RECTIFIER

Reverse Voltage - 50 to 1000 Volts Forward Current - 1.0Ampere

SOD-123FL



Dimensions in millimeters

FEATURES

- ◆ Glass passivated device
- ◆ Ideal for surface mounted applications
- ◆ Low reverse leakage
- ◆ Metallurgically bonded construction
- ◆ High temperature soldering guaranteed:
250°C/10 seconds, 0.375" (9.5mm) lead length,
5 lbs. (2.3kg) tension

MECHANICAL DATA

Case : JEDEC SOD-123FL molded plastic body over passivated chip

Terminals : Plated axial leads, solderable per MIL-STD-750, Method 2026

Polarity : Color band denotes cathode end

Mounting Position : Any

Weight : 0.0007 ounce, 0.02 grams

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

	SYMBOLS	RS1AL	RS1BL	RS1DL	RS1GL	RS1JL	RS1KL	RS1ML	UNITS
	MARK	RA	RB	RD	RG	RJ	RK	RM	
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	VOLTS
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	VOLTS
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	VOLTS
Maximum average forward rectified current at $T_A=65^\circ\text{C}$ (NOTE 1)	$I_{(AV)}$	1.0							Amp
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method) $T_L=25^\circ\text{C}$	I_{FSM}	25.0							Amps
Maximum instantaneous forward voltage at 1.0A	V_F	1.3							Volts
Maximum DC reverse current $T_A=25^\circ\text{C}$ at rated DC blocking voltage $T_A=125^\circ\text{C}$	I_R	5.0 50.0							μA
Maximum reverse recovery time (NOTE 2)	t_{rr}	150				250	500		ns
Typical junction capacitance (NOTE 3)	C_J	4							pF
Typical thermal resistance (NOTE 4)	$R_{\theta JA}$	180							K/W
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150							$^\circ\text{C}$

Note: 1. Averaged over any 20ms period.

2. Measured with $I_F=0.5\text{A}$, $I_R=1\text{A}$, $I_{rr}=0.25\text{A}$.

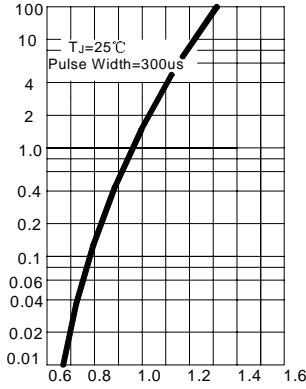
3. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

4. Thermal resistance junction to ambient, 6.0 mm² copper pads to each terminal.

RATINGS AND CHARACTERISTIC CURVES RS1AL THRU RS1ML

FIG.1 –TYPICAL FORWARD CHARACTERISTIC

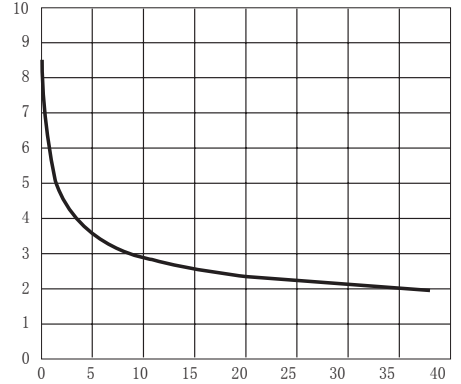
INSTANTANEOUS FORWARD CURRENT
AMPERES



INSTANTANEOUS FORWARD VOLTAGE, V

FIG.2 – TYPICAL JUNCTION CAPACITANCE

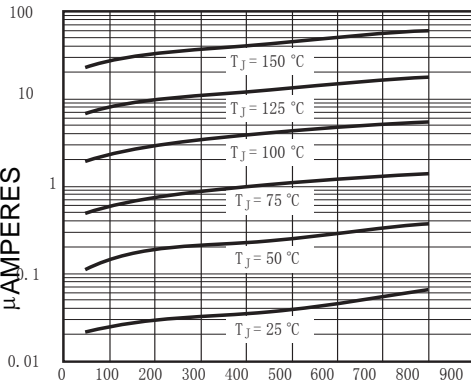
CAPACITANCE, pF



REVERSE VOLTAGE, VOLTS

FIG.3 – TYPICAL INSTANTANEOUS REVERSE CHARACTERISTICS

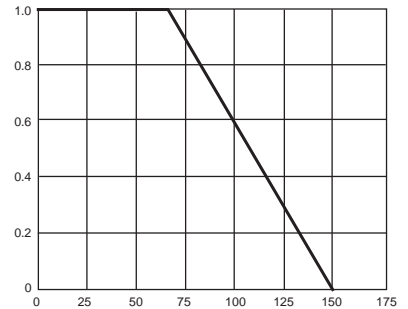
INSTANTANEOUS REVERSE CURRENT
 μ AMPERES



INSTANTANEOUS REVERSE VOLTAGE, V

FIG.4 – FORWARD DERATING CURVE

AVERAGE FORWARD CURRENT,
AMPERES



AMBIENT TEMPERATURE, $^\circ\text{C}$

